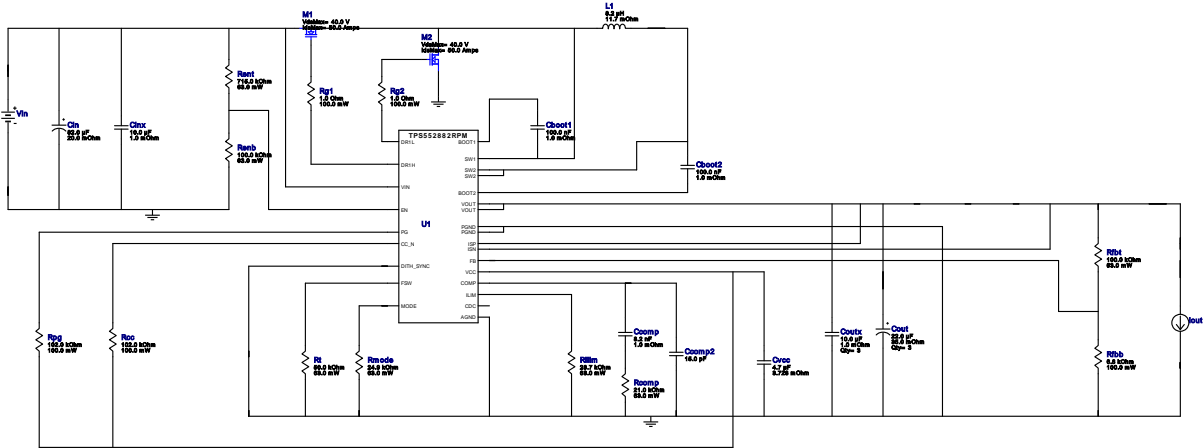
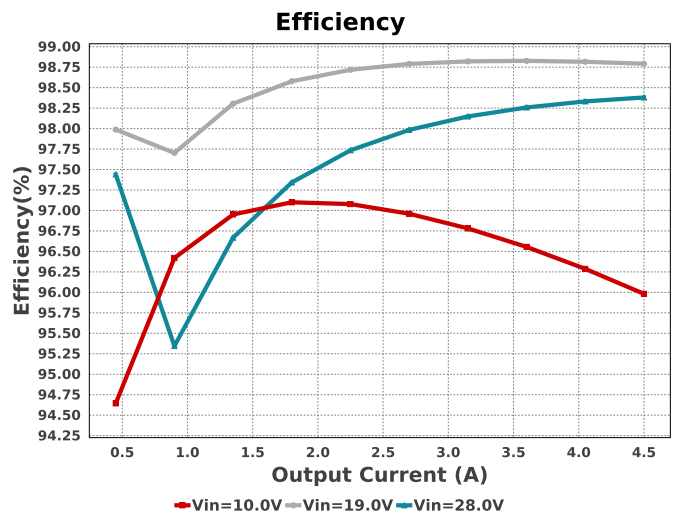
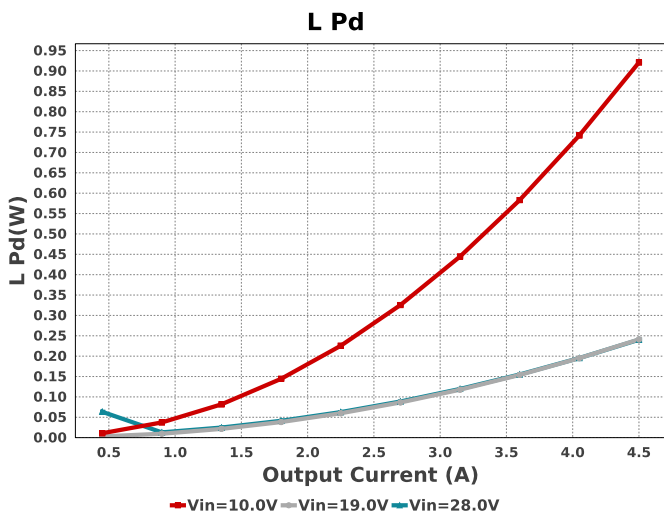
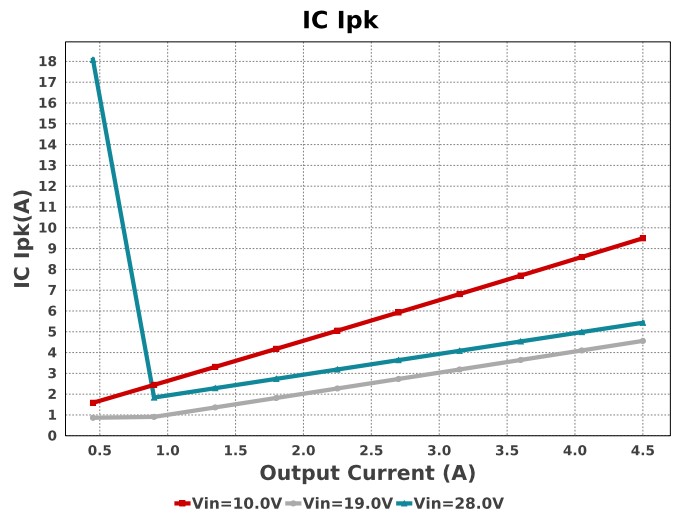
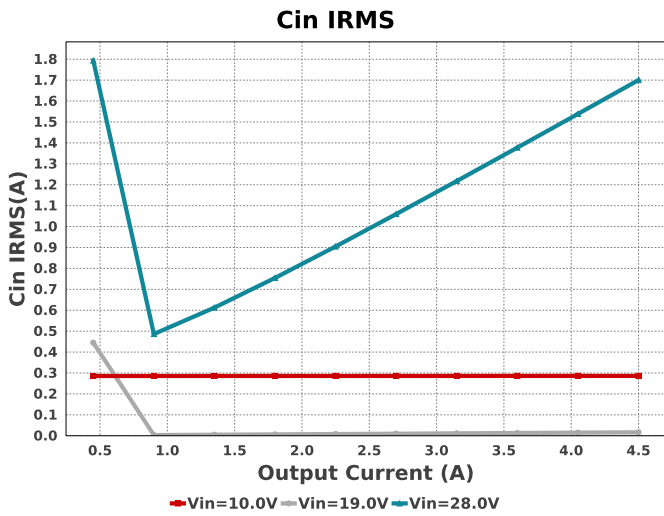
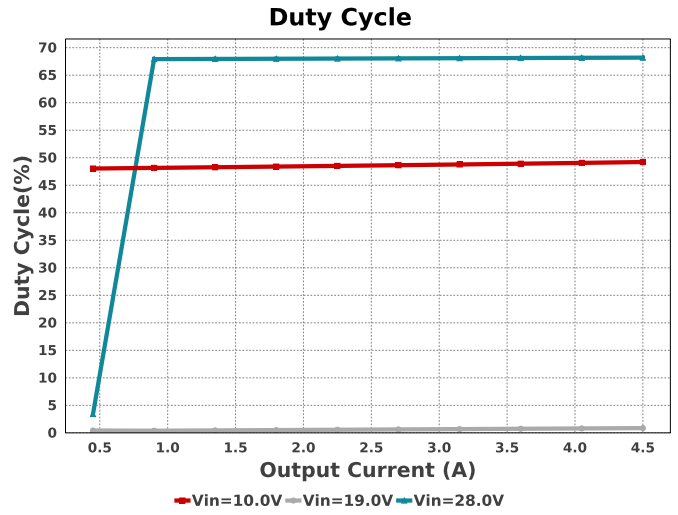
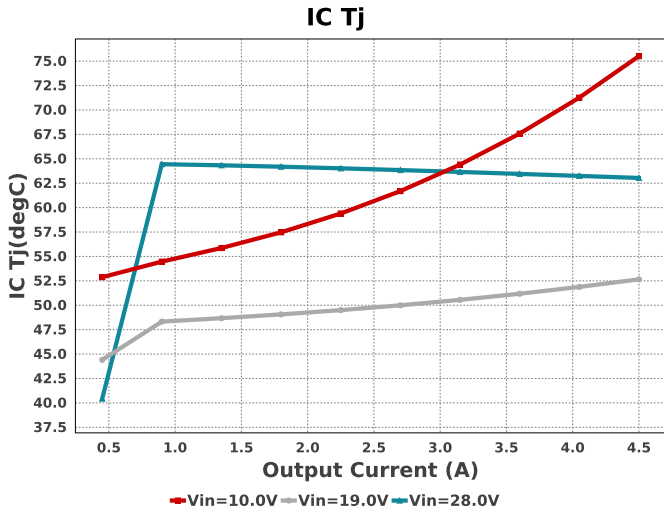


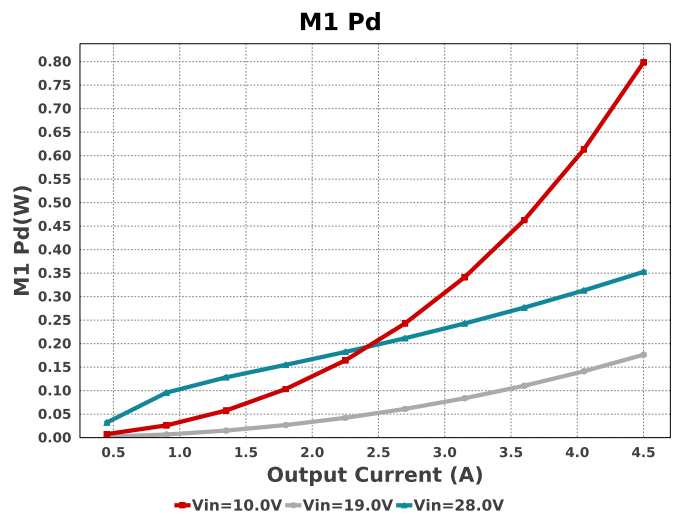
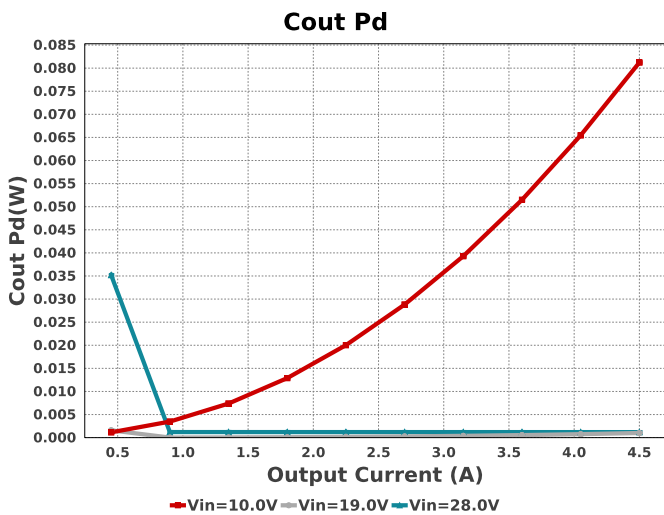
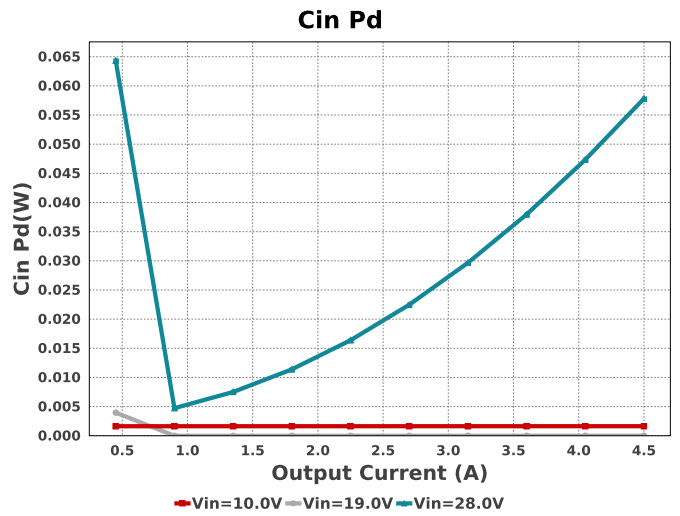
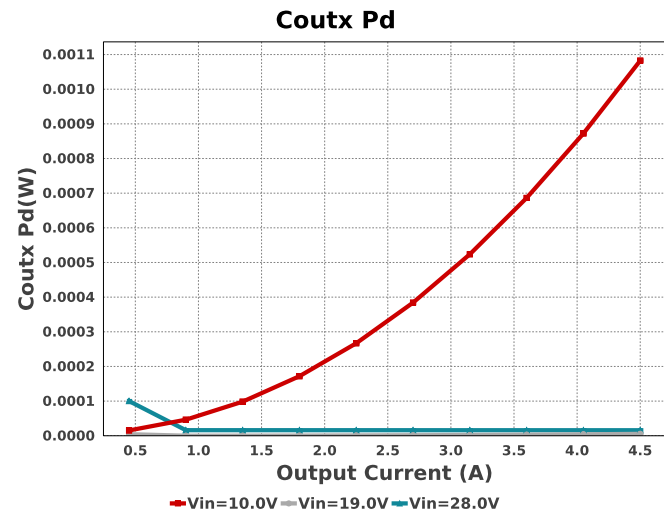
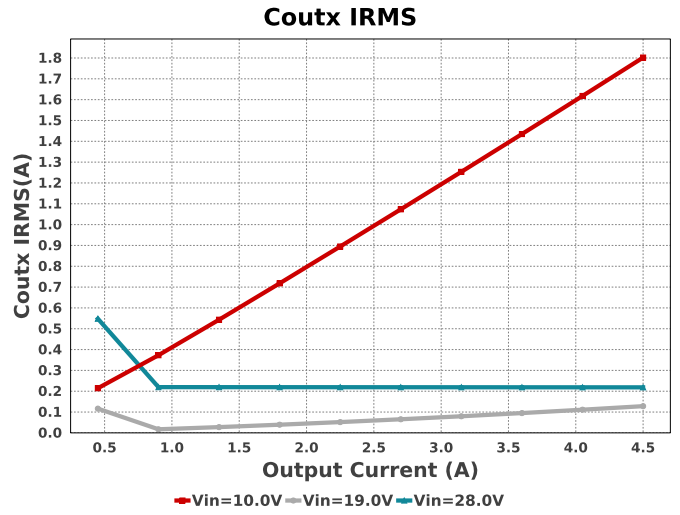
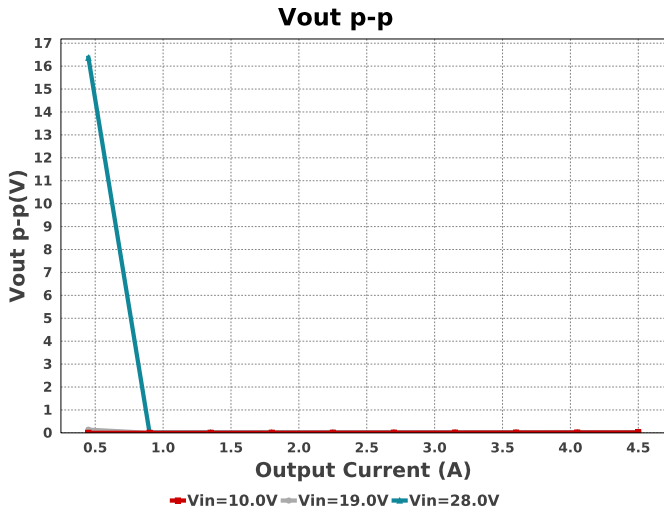
WEBENCH® Design Report

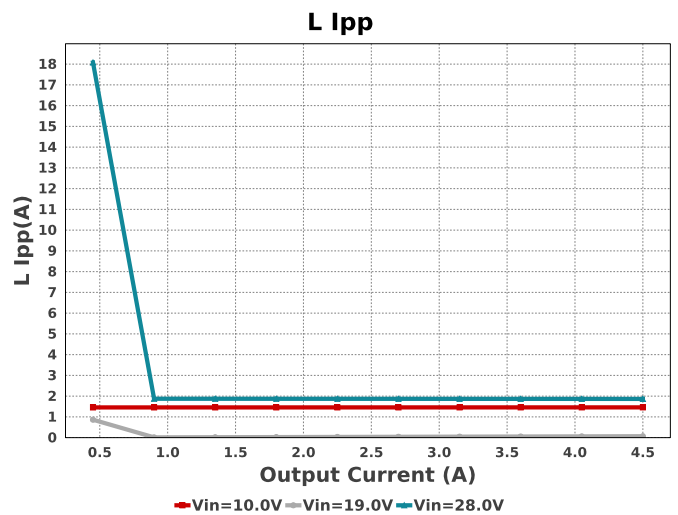
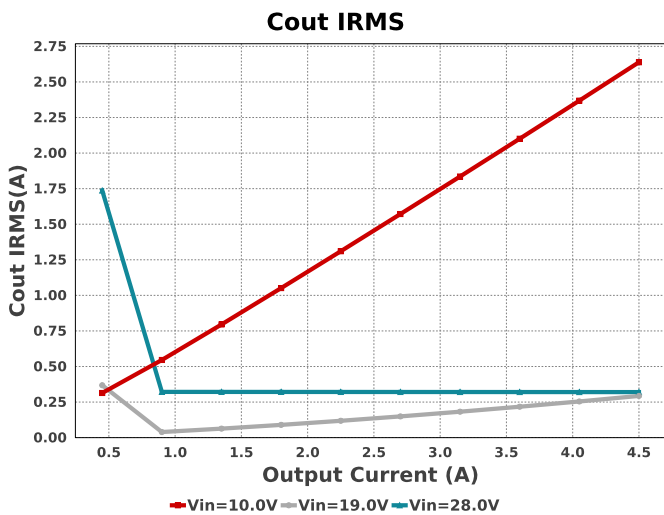
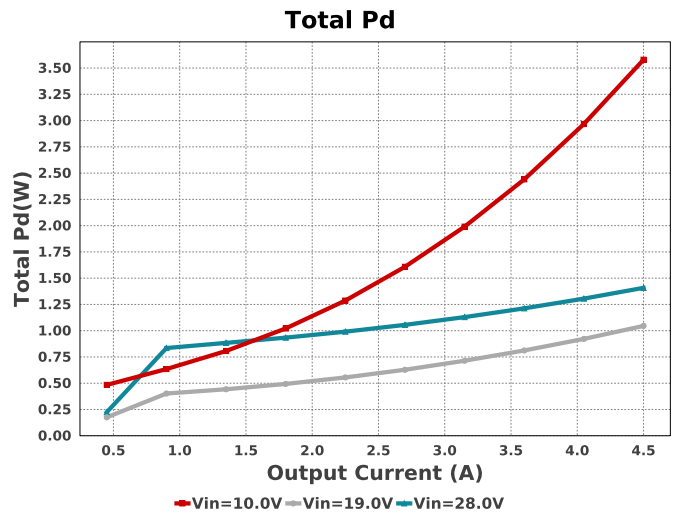
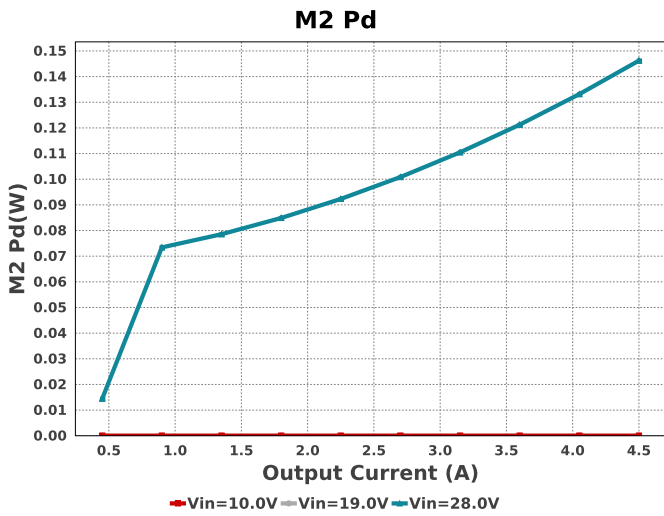
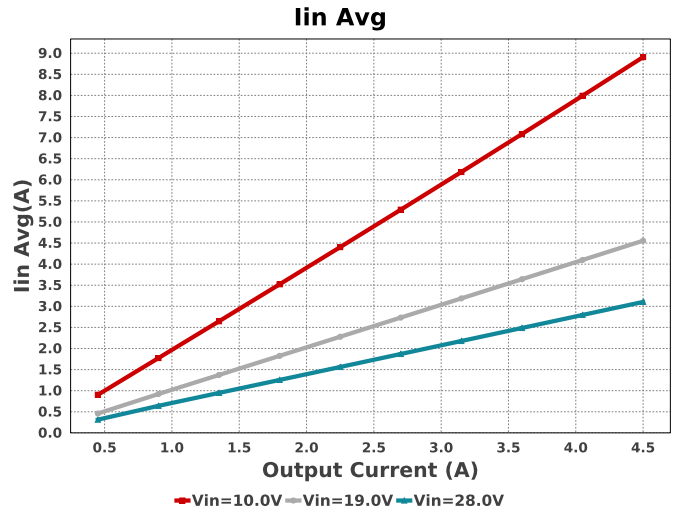
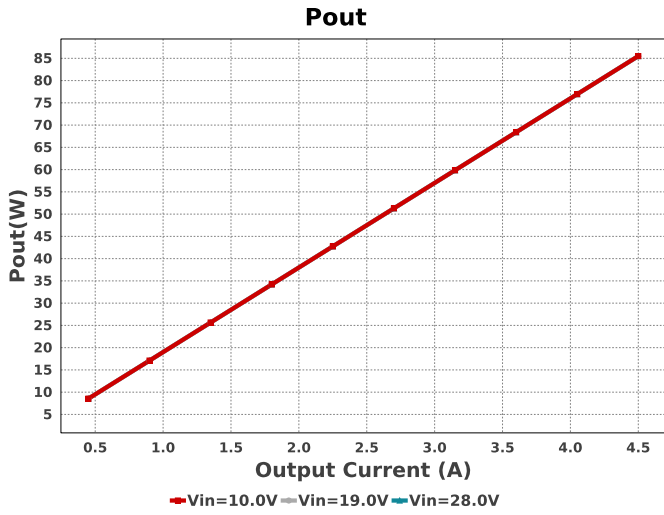
 Design : 43 TPS552882RPMR
 TPS552882RPMR 10V-28V to 19.00V @ 4.5A

Electrical BOM

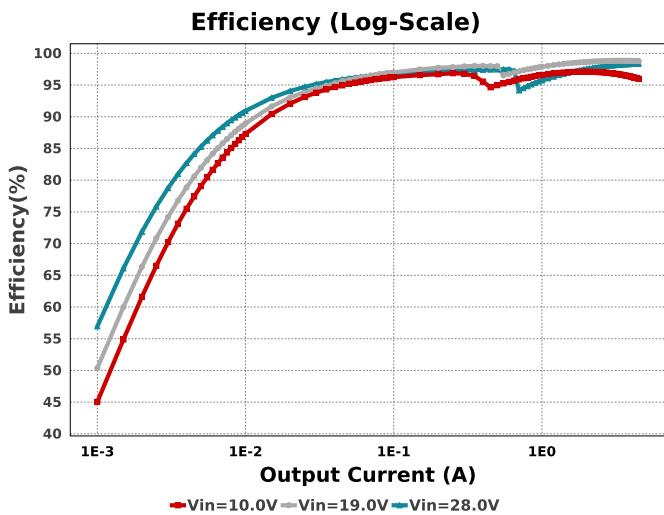
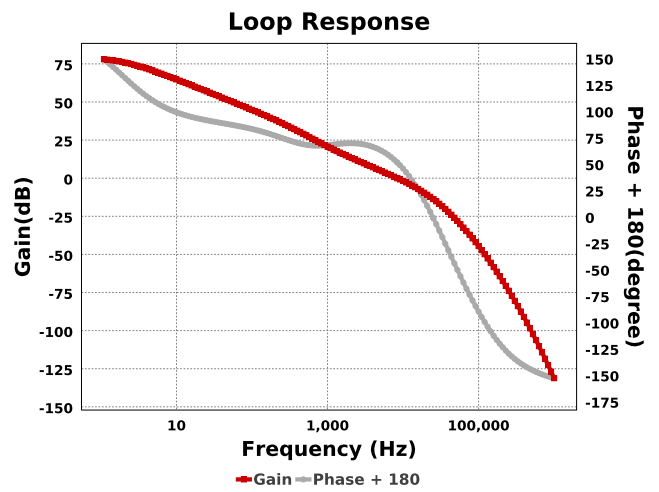
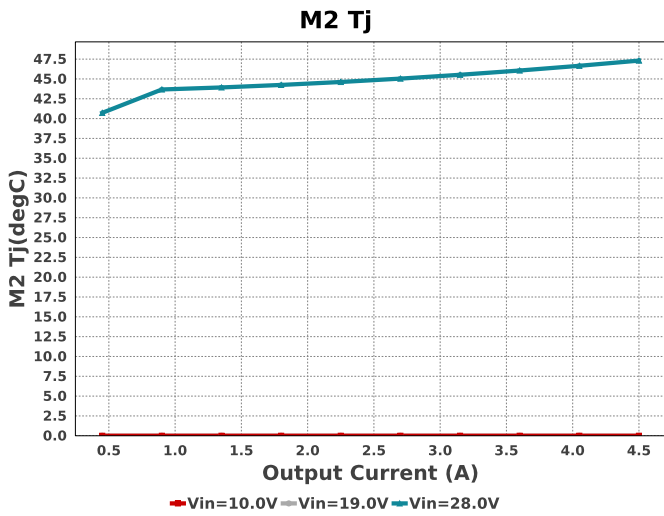
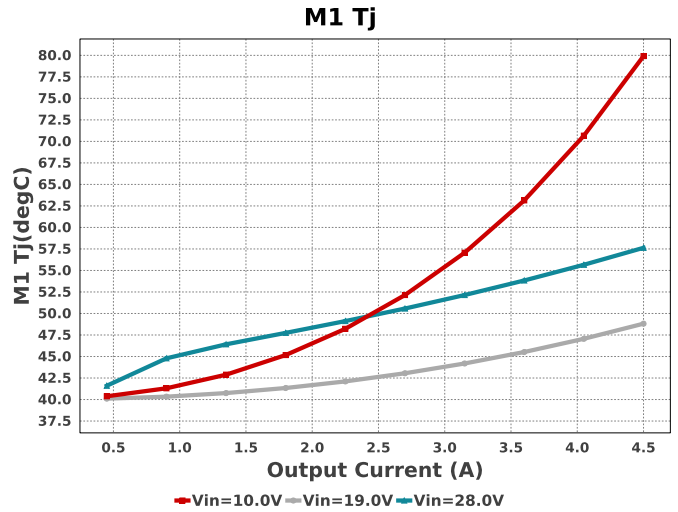
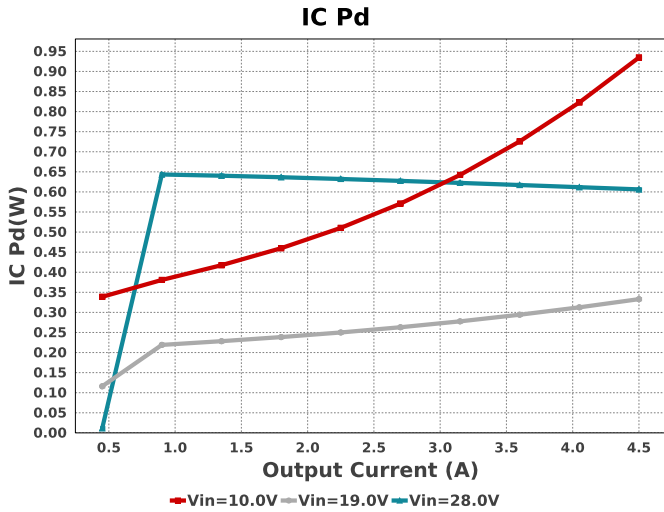
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cboot1	Taiyo Yuden	EMK107B7104KA-T Series= X7R	Cap= 100.0 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0603 5 mm ²
Cboot2	Taiyo Yuden	EMK107B7104KA-T Series= X7R	Cap= 100.0 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0603 5 mm ²
Ccomp	MuRata	GRM155R71C822KA01D Series= X7R	Cap= 8.2 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm ²
Ccomp2	Kemet	C0402C150J4GACTU Series= C0G/NP0	Cap= 15.0 pF VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm ²
Cin	Panasonic	35SVPF82M Series= SVPF	Cap= 82.0 uF ESR= 20.0 mOhm VDC= 35.0 V IRMS= 4.0 A	1	\$1.17	 CAPSMT_62_E12 106 mm ²
Cinx	TDK	C3225X7R1H106M250AC Series= X7R	Cap= 10.0 uF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 5.0 A	1	\$0.27	1210 15 mm ²
Cinx2	TDK	C1608X5R1H105K080AB Series= X5R	Cap= 1.0 uF ESR= 5.522 mOhm VDC= 50.0 V IRMS= 2.2162 A	1	\$0.03	0603 5 mm ²
Cout	Panasonic	35SVPF22M Series= SVPF	Cap= 22.0 uF ESR= 35.0 mOhm VDC= 35.0 V IRMS= 2.6 A	3	\$0.57	 CAPSMT_62_F61 74 mm ²
Coutx	TDK	C3225X7R1H106M250AC Series= X7R	Cap= 10.0 uF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 5.0 A	3	\$0.27	1210 15 mm ²

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Coutx2	TDK	C1005X5R1V105K050BC Series= X5R	Cap= 1.0 uF ESR= 11.416 mOhm VDC= 35.0 V IRMS= 1.483 A	1	\$0.03	 0402 3 mm ²
Cvcc	TDK	C1608X6S1C475K080AC Series= X6S	Cap= 4.7 uF ESR= 3.728 mOhm VDC= 16.0 V IRMS= 2.69359 A	1	\$0.08	 0603 5 mm ²
L1	Coilcraft	XAL1010-822MEB	L= 8.2 uH 11.7 mOhm	1	\$1.71	 XAL1010 160 mm ²
M1	Texas Instruments	CSD18514Q5A	VdsMax= 40.0 V IdsMax= 50.0 Amps	1	\$0.28	 TRANS_NexFET_Q5A 55 mm ²
M2	Texas Instruments	CSD18514Q5A	VdsMax= 40.0 V IdsMax= 50.0 Amps	1	\$0.28	 TRANS_NexFET_Q5A 55 mm ²
Rcc	Vishay-Dale	CRCW0603102KFKEA Series= CRCW..e3	Res= 102.0 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm ²
Rcomp	Vishay-Dale	CRCW040221K0FKED Series= CRCW..e3	Res= 21.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Renb	Vishay-Dale	CRCW0402100KFKEA Series= CRCW..e3	Res= 100.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rent	Vishay-Dale	CRCW0402715KFKEA Series= CRCW..e3	Res= 715.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rfbb	Yageo	RC0603FR-076K8L Series= ?	Res= 6.8 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm ²
Rfbt	Vishay-Dale	CRCW0402100KFKEA Series= CRCW..e3	Res= 100.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rg1	Vishay-Dale	CRCW06031R00FKEA Series= CRCW..e3	Res= 1.0 Ohm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm ²
Rg2	Vishay-Dale	CRCW06031R00FKEA Series= CRCW..e3	Res= 1.0 Ohm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm ²
Rilim	Yageo	AC0402FR-0728K7L Series= ?	Res= 28.7 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rmode	Vishay-Dale	CRCW040224K9FKED Series= CRCW..e3	Res= 24.9 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rpg	Vishay-Dale	CRCW0603102KFKEA Series= CRCW..e3	Res= 102.0 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm ²
Rt	Vishay-Dale	CRCW040250K0FKED Series= 0402	Res= 50.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
U1	Texas Instruments	TPS552882RPMR	Switcher	1	\$2.90	RPM0026A-MFG 22 mm ²









Operating Values

#	Name	Value	Category	Description
1.	BOM Count	31		Total Design BOM count
2.	Total BOM	\$9.429		Total BOM Cost
3.	Cin IRMS	286.173 mA	Capacitor	Input capacitor RMS ripple current
4.	Cin Pd	1.638 mW	Capacitor	Input capacitor power dissipation
5.	Cout IRMS	2.639 A	Capacitor	Output capacitor RMS ripple current
6.	Cout Pd	81.221 mW	Capacitor	Output capacitor power dissipation
7.	Coutx IRMS	1.802 A	Capacitor	Output capacitor_x RMS ripple current
8.	Coutx Pd	1.082 mW	Capacitor	Output capacitor_x power loss
9.	IC Ipk	9.495 A	IC	Peak switch current in IC
10.	IC Pd	934.66 mW	IC	IC power dissipation
11.	IC Tj	75.517 degC	IC	IC junction temperature

#	Name	Value	Category	Description
12.	IC Tolerance	12.0 mV	IC	IC Feedback Tolerance
13.	ICThetaJA	38.0 degC/W	IC	IC junction-to-ambient thermal resistance
14.	Iin Avg	8.908 A	IC	Average input current
15.	L Ipp	1.459 A	Inductor	Peak-to-peak inductor ripple current
16.	L Pd	920.92 mW	Inductor	Inductor power dissipation
17.	M1 Pd	798.27 mW	Mosfet	M1 MOSFET total power dissipation
18.	M1 Tj	79.914 degC	Mosfet	M1 MOSFET junction temperature
19.	M2 Pd	0.0 W	Mosfet	M2 MOSFET total power dissipation
20.	M2 Tj	0.0 degC	Mosfet	M2 MOSFET junction temperature
21.	Cin Pd	1.638 mW	Power	Input capacitor power dissipation
22.	Cout Pd	81.221 mW	Power	Output capacitor power dissipation
23.	Coutx Pd	1.082 mW	Power	Output capacitor_x power loss
24.	IC Pd	934.66 mW	Power	IC power dissipation
25.	L Pd	920.92 mW	Power	Inductor power dissipation
26.	M1 Pd	798.27 mW	Power	M1 MOSFET total power dissipation
27.	M2 Pd	0.0 W	Power	M2 MOSFET total power dissipation
28.	Total Pd	3.579 W	Power	Total Power Dissipation
29.	Cross Freq	4.762 kHz	System	Bode plot crossover frequency
30.	Duty Cycle	49.221 %	System Information	Duty cycle
31.	Efficiency	95.982 %	System Information	Steady state efficiency
32.	FootPrint	751.0 mm ²	System Information	Total Foot Print Area of BOM components
33.	Frequency	396.825 kHz	System Information	Switching frequency
34.	Gain Marg	-10.337 dB	System Information	Bode Plot Gain Margin
35.	Iout	4.5 A	System Information	Iout operating point
36.	Low Freq Gain	66.389 dB	System Information	Gain at 1Hz
37.	Mode	CCM	System Information	Conduction Mode
38.	Phase Marg	59.225 deg	System Information	Bode Plot Phase Margin
39.	Pout	85.5 W	System Information	Total output power
40.	Vin	10.0 V	System Information	Vin operating point
41.	Vout	19.0 V	System Information	Operational Output Voltage
42.	Vout Actual	18.847 V	System Information	Vout Actual calculated based on selected voltage divider resistors
43.	Vout Tolerance	2.91 %	System Information	Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable
44.	Vout p-p	17.311 mV	System Information	Peak-to-peak output ripple voltage

Design Inputs

Name	Value	Description
Iout	4.5	Maximum Output Current
VinMax	28.0	Maximum input voltage
VinMin	10.0	Minimum input voltage
Vout	19.0	Output Voltage
base_pn	TPS552882	Base Product Number
source	DC	Input Source Type
Ta	40.0	Ambient temperature
UserFsw	396.825 k	Customer Selected Frequency

WEBENCH® Assembly

Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of C_{in} and C_{out} , and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

Soldering Component to Board

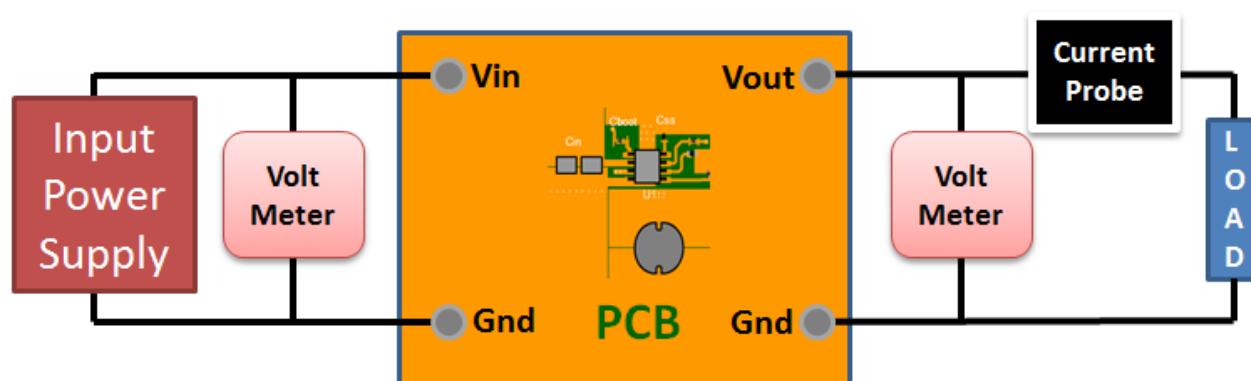
If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab down to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 10.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to V_{in} and GND. Connect a digital volt meter and a load if needed to set the minimum load of the design from V_{out} and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between V_{in} and GND, a load is connected between V_{out} and GND and a current meter is connected in series between V_{out} and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



Design Assistance

1. Master key : 3E2BB7957E62AB67782B637E9583A824[v1]
2. **TPS552882** Product Folder : <http://www.ti.com/product/TPS552882> : contains the data sheet and other resources.

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